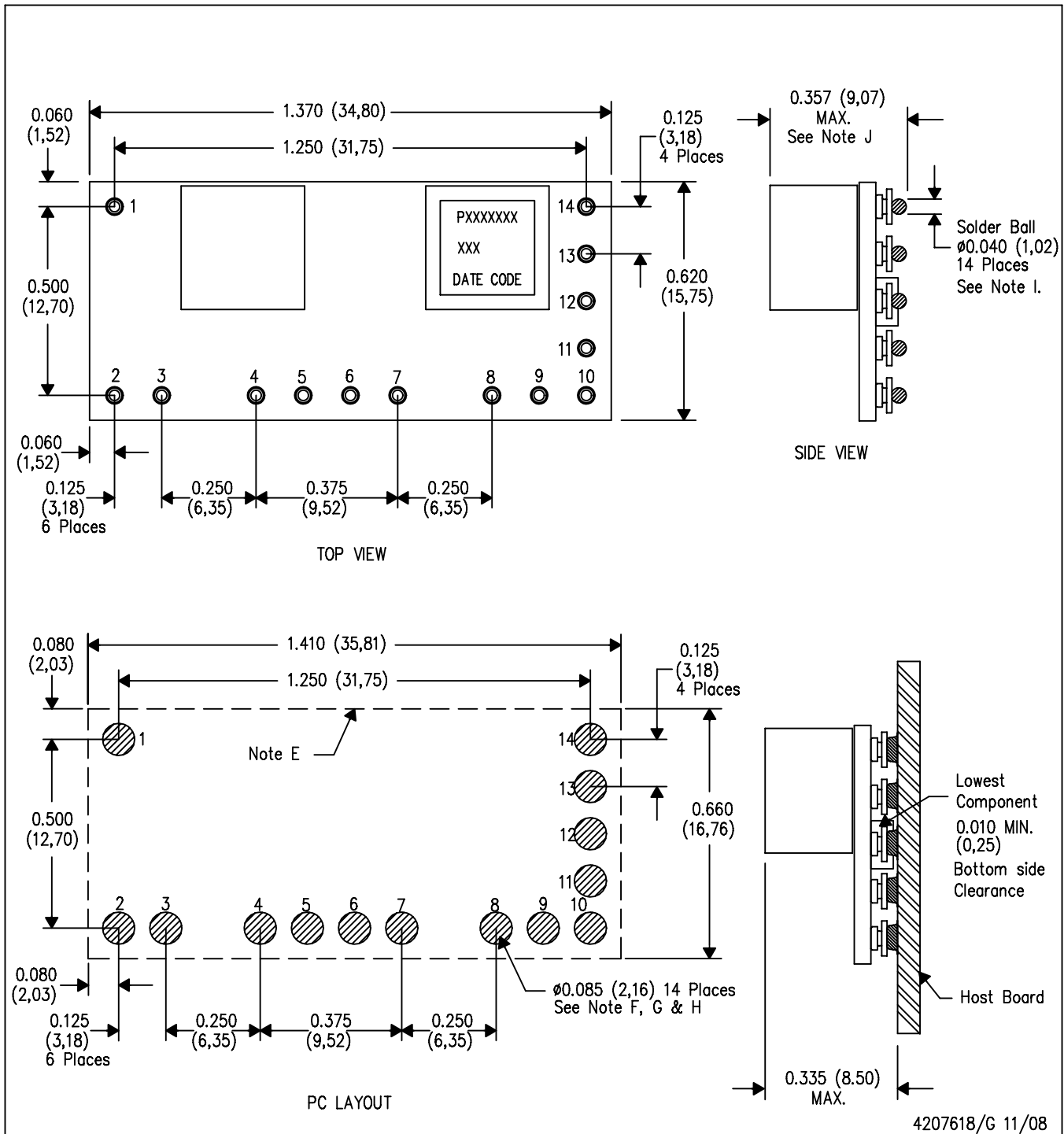


ECQ (R-PDSS-B14)

DOUBLE SIDED MODULE



NOTES:

- All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- 2 place decimals are ± 0.030 ($\pm 0,76$ mm).
- 3 place decimals are ± 0.010 ($\pm 0,25$ mm).
- Recommended keep out area for user components.
- Power pin connection should utilize two or more vias to the interior power plane of 0.025 (0,63) I.D. per input, ground and output pin (or the electrical equivalent).

- Paste screen opening: 0.080 (2,03) to 0.085 (2,16).
Paste screen thickness: 0.006 (0,15).
- Pad type: Solder mask defined.
- All pins: Material - Copper Alloy
Finish - Tin (100%) over Nickel plate
Solder Ball - See product data sheet.
- Dimension prior to reflow solder.

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